

TN01P20KDC

Features

- ESD protected(HBM) up to 2KV
- VDS= -20V,ID= -0.65A RDS(on)< 850m Ω @V_{GS}= -4.5V
- Halogen and Antimony Free
- Moisture Sensitivity Level 1
- RoHS Compliant

P-Channel Enhancement Mode Power MOSFET

Pin	Description		1		2
1	Gate				
2	Source				
3	Drain			3	
(Bottom View					

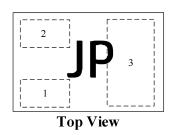
Mechanical Characteristics

- Package:DFN 1006-3L
- Packaging: Tape and Reel per EIA 481
- Marking : Making Code
- RoHS Compliant

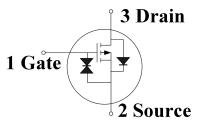
Applications

- Load Switch
- PWM applications
- Power Management

Marking: Making Code



Schematic Diagram



Absolute Maximum Rating(Ratings at 25 °C ambient temperature unless otherwise specified.)

Parameter	Symbols	Value	Unit	
Drain-Source Voltage	$ m V_{DS}$	20	V	
Gate-Source Voltage	$ m V_{GS}$	±12	V	
Drain Current-Continuous	I_D	0.65	A	
Drain Current-Pulsed Note1	I_{DM}	2	A	
Junction Temperature	P_{D}	0.35	W	
Maximum Power Dissipation	T_{J}	150	°C	
Storage Temperature Range	T_{STG}	-55 to +150	°C	

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient Note2	$R_{\theta JA}$	357	°C/W
---	-----------------	-----	------

Electrical Characteristics(Tc=25°C Unless otherwise specified)

Parameter	Symbols	Test Condition	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{GS} = 0$ V, $I_D = -250$ µA		20			V	
Zero Gate Voltage Drain Current	$-I_{DSS}$	V_{DS} = $-20V$, V_{GS} = $0V$			1	μΑ	
Gate-Body Leakage Current	I _{GSS}	$V_{GS}\!\!=\!\!\pm10V,\!V_{DS}\!\!=\!\!0V$			±10	μΑ	
Gate Threshold Voltage Note3	$-\mathrm{V}_{\mathrm{GS(th)}}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	0.35	0.62	1.2	V	
Drain-Source On-Resistance Note3	ъ	$V_{GS} = -4.5V, I_D = -0.5A$		580	850	m Ω	
Drain-Source On-Resistance	R _{DS(ON)}	$V_{GS} = -2.5V, I_D = -0.3A$		855	1200	m Ω	
Forward Transconductance Note3	gfs	$V_{DS} = -5V, I_D = -0.3A$		2		S	
Dynamic Characteristics							
Input Capacitance	C _{iss}			71		pF	
Output Capacitance	Coss	V_{DS} =-10V, V_{GS} =0V, f =1MHz		20		pF	
Reverse Transfer Capacitance	C _{rss}			15		pF	
Total Gate Charge	Qg	V 10VI 0.5A V		1.24		nC	
Gate-Source Charge	Qgs	V_{DS} =-10V, I_D =-0.5A, V_{GS} = -4.5V		0.37		nC	
Gate-Drain Charge	Qgd	4.3 V		0.27		nC	
Switching Characteristics							
Turn-on Delay Time	t _{d(on)}			4		nS	
Turn-on Rise Time	t _r	$V_{DD} = -10V, R_L = 2.5\Omega, V_{GS} = -$		19		nS	
Turn-off Delay Time	t _{d(off)}	4.5 V, R_{GEN} = 3Ω		16		nS	
Turn-off Fall Time	t_{f}	1		25		nS	
Source-Drain Diode Characteristics							
Diode Forward Voltage Note3	$-\mathrm{V}_{\mathrm{SD}}$	$V_{GS}=0V,I_{S}=0.65A$			1.2	V	
Diode Forward Current Note2	$-I_{S}$				0.65	A	

Notes:

- Repetitive Rating: Pulse width limited by maximum junction temperature.
- Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.
- Pulse Test: Pulse width≤300 μ s, duty cycle≤0.5%.

Typical Characteristics Curves

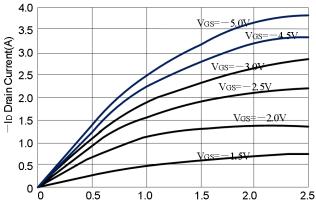


Figure 1. - VDS Drain-Source Voltage(V)

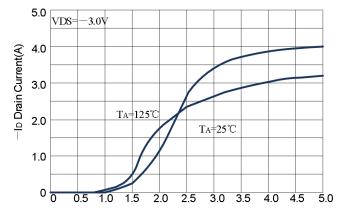
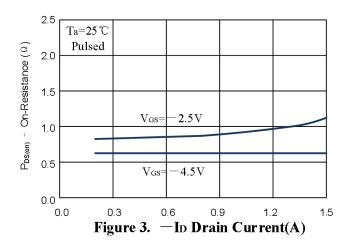
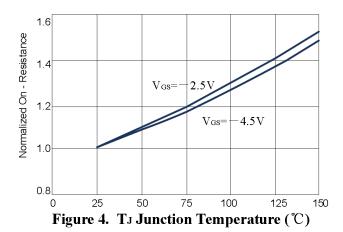
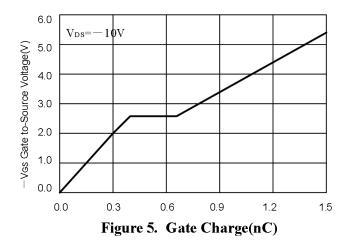
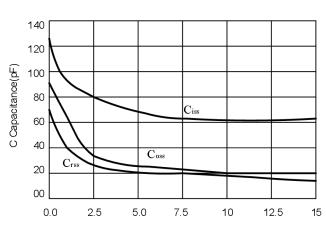


Figure 2. - VGS Gate-Source Voltage(V)









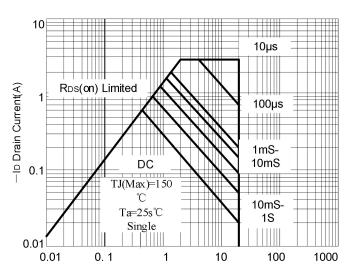


Figure 6. -VDS Drain-Source Voltage(V)

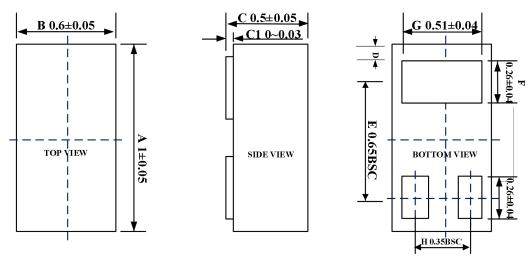
Figure 7. - VDS Drain-Source Voltage

Package Information

Package Type	Description	Quantity (pcs)	Standard
DFN1006-3L	Tape & Reel -7" tape	10000	EIA-481

Outline Drawing - DFNx0.6-3L-0009

Dimensions in mm



DIM	INCHES		MM		NOTE	
	MIN	MAX	MIN	MAX	NOTE	
A	0.037	0.041	0.95	1.05		
В	0.022	0.026	0.55	0.65		
C	0.016	0.022	0.40	0.50		
C 1		0.004		0.05		
D	0.001	0.003	0.02	0.08		
E	0.0	026	0.	65	TYP.	
F	0.008	0.012	0.20	0.30		
G	0.018	0.022	0.45	0.55		

Contact Information

For additional information, please contact your local Sales Representative.



® is registered trademarks of TANI Corporation.

Product Specification Statement

The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical

The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up -to- date information to the best of our ability. However, due to technical, human, or other reasons, TANI cannot guarantee that the information provided in the product specification is entirely accurate and error-free. TANI shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications.

TANI reserves the right to revise or update the product specification and the products at any time without prior notice, and the user's continued use of the product specification is considered an acceptance of these revisions and updates. Prior to purchasing and using the product, users should verify the above information with TANI to ensure that the product specification is the most current, effective, and complete. If users are particularly concerned about product parameters, please consult TANI in detail or request relevant product test reports. Any data not explicitly mentioned in the product specification shall be subject to separate agreement.

Users are advised to pay attention to the parameter limit values specified in the product specification and maintain a certain margin in design or application to ensure that the product does not exceed the parameter limit values defined in the product specification. This precaution should be taken to avoid exceeding one or more of the limit values, which may result in permanent irreversible damage to the product, ultimately affecting the quality and reliability of the system or equipment.

The design of the product is intended to meet civilian needs and is not guaranteed for use in harsh environments or precision equipment. It is not recommended for use in systems or equipment such as medical devices, aircraft, nuclear power, and similar systems, where failures in these systems or equipment could reasonably be expected to result in personal injury. TANI shall assume no responsibility for any consequences resulting from such usage.

Users should also comply with relevant laws, regulations, policies, and standards when using the product specification. Users are responsible for the risks and liabilities arising from the use of the product specification and must ensure that it is not used for illegal purposes. Additionally, users should respect the intellectual property rights related to the product specification and refrain from infringing upon any third- party legal rights. TANI shall assume no responsibility for any disputes or controv ersies arising from the above-mentioned issues in any form.